

**BoHS** 

COMPLIANT

# **Standard Thick Film Chip Resistors**



### FEATURES

- Stability  $\Delta R/R = 1$  % for 1000 h at 70 ° C
- 2 mm pitch packaging option for 0603 size
- Pure tin solder contacts on Ni barrier layer HALOGEN provides compatibility with lead (Pb)-free and lead containing soldering processes
- Metal glaze on high quality ceramic
- AEC-Q200 qualified
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

STANDARD ELECTRICAL SPECIFICATIONS												
MODEL	SIZE				TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES				
D10/CRCW0402	0402	RR 1005M	0.063	50	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24				
			Zero-Ohm-Resistor	: <i>R</i> <sub>max.</sub> = 20 mΩ	g, <i>I</i> <sub>max.</sub> at 70 °C = 1.	5 A						
D11/CRCW0603	0603	RR 1608M	0.10	75	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24				
			Zero-Ohm-Resistor	$R_{\text{max.}} = 20 \text{ m}\Omega$	, <i>I</i> <sub>max.</sub> at 70 °C = 2.0	D A	•	•				
D12/CRCW0805	0805	0805	0805	0805	0805	RR 2012M	0.125	150	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24
			Zero-Ohm-Resistor: $R_{max.} = 20 \text{ m}\Omega$ , $I_{max.}$ at 70 °C = 2.5 A									
D25/CRCW1206	1206	RR 3216M	0.25	200	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24				
			Zero-Ohm-Resistor: $R_{max.} = 20 \text{ m}\Omega$ , $I_{max.}$ at 70 °C = 3.5 A									
CRCW1210	1210	1210	RR 3225M	0.5	200	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24			
			Zero-Ohm-Resistor: $R_{max.}$ = 20 mΩ, $I_{max.}$ at 70 °C = 5.0 A									
CRCW1218	1218	RR 3246M	1.0	200	± 100 ± 200	± 1 ± 5	1R0 to 2M2	E24; E96 E24				
			Zero-Ohm-Resistor: $R_{\text{max.}}$ = 20 mΩ, $I_{\text{max.}}$ at 70 °C = 7.0 A									
CRCW2010	2010	2010	2010	2010	RR 5025M	0.75	400	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24	
			Zero-Ohm-Resistor: $R_{\text{max.}} = 20 \text{ m}\Omega$ , $I_{\text{max.}}$ at 70 °C = 6.0 A									
CRCW2512	2512	RR 6332M	1.0	500	± 100 ± 200	± 1 ± 5	1R0 to 10M	E24; E96 E24				
				Zero-Ohm-Resistor	$R_{\rm max.} = 20 \ {\rm m}\Omega$	g, <i>I</i> <sub>max.</sub> at 70 °C = 7.0	D A					

#### Notes

• These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

• Marking: See data sheet "Surface Mount Resistor Marking" (document number 20020).

• Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.

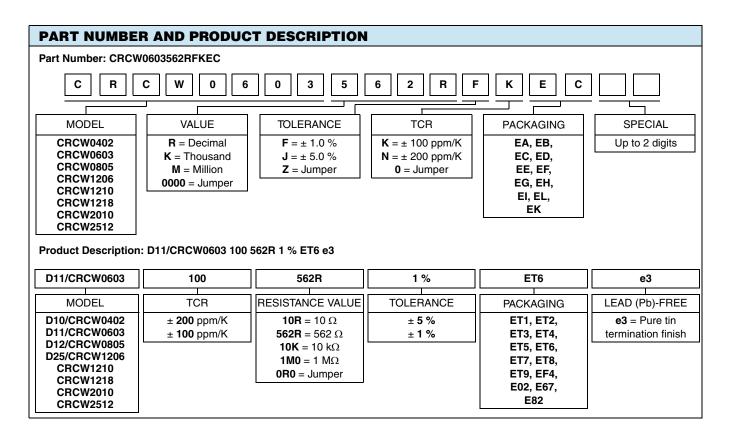
### Standard Thick Film Chip Resistors



TECHNICAL SPECIFICATIONS									
PARAMETER	UNIT	D10/ CRCW0402	D11/ CRCW0603	D12/ CRCW0805	D25/ CRCW1206	CRCW1210	CRCW1218	CRCW2010	CRCW2512
Rated dissipation $P_{70}^{(1)}$	w	0.063	0.1	0.125	0.25	0.5	1.0	0.75	1.0
Limiting element voltage U <sub>max.</sub> AC/DC	v	50	75	150	200	200	200	400	500
Insulation voltage <i>U</i> <sub>ins</sub> (1 min)	v	> 75	> 100	> 200	> 300	> 300	> 300	> 300	> 300
Insulation resistance Ω					> `	10 <sup>9</sup>			
Category temperature range	°C	- 55 to + 155							
Failure rate	Failure rate h <sup>-1</sup> < 0.1 x 10 <sup>-9</sup>								
Weight	mg	0.65	2	5.5	10	16	29.5	25.5	40.5

#### Note

<sup>(1)</sup> The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 °C is not exceeded.



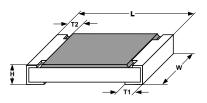


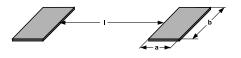
## Standard Thick Film Chip Resistors

Vishay

PACKAGING								
MODEL	CODE	QUANTITY	CARRIER TAPE	WIDTH	PITCH	REEL DIAMETER		
CRCW0402	ED = ET7	10 000		8 mm	2 mm	180 mm/7"		
000402	EE = EF4	50 000				330 mm/13"		
	EI = ET2	5000				180 mm/7"		
	ED = ET3	10 000		8 mm	2 mm	180 mm/7"		
	EL = ET4	20 000		0 11111	2 11111	285 mm/11.25"		
CRCW0603	EE = ET8	50 000				330 mm/13"		
	EA = ET1	5000		8 mm		180 mm/7"		
	EB = ET5	10 000			4 mm	285 mm/11.25"		
	EC = ET6	20 000	Paper tape acc. to IEC 60068-3			330 mm/13"		
	EA = ET1	5000	Type I	8 mm	4 mm	180 mm/7"		
CRCW0805	EB = ET5	10 000	iypor			285 mm/11.25"		
	EC = ET6	20 000				330 mm/13"		
	EA = ET1	5000				180 mm/7"		
CRCW1206	EB = ET5	10 000		8 mm	4 mm	285 mm/11.25"		
	EC = ET6	20 000				330 mm/13"		
	EA = ET1	5000				180 mm/7"		
CRCW1210	EB = ET5	10 000		8 mm	4 mm	285 mm/11.25"		
	EC = ET6	20 000				330 mm/13"		
CRCW1218	EK = ET9	4000		12 mm	4 mm	180 mm/7"		
CRCW2010	EF = E02	4000	Blister tape acc.	12 mm	4 mm	180 mm/7"		
	EG = E67	2000	to IEC 60068-3 Type II		8 mm	100 mm/7"		
CRCW2512	EH = E82	4000	1,50	12 mm	4 mm	180 mm/7"		

#### DIMENSIONS



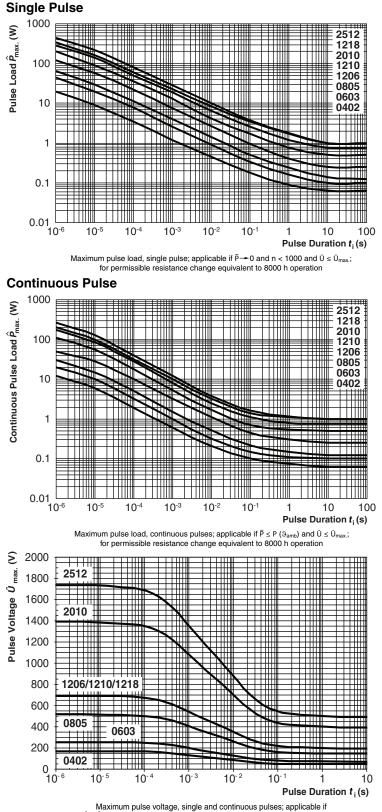


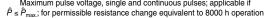
	IZE		DIMENSIONS in millimeters					SOLDER PAD DIMENSIONS in millimeters					
3								REFLOW SOLDERING			WAVE SOLDERING		
INCH	METRIC	L	W	Н	T1	T2	а	b	I	а	b	I	
0402	1005	$1.0 \pm 0.05$	$0.5 \pm 0.05$	$0.35\pm0.05$	$0.25\pm0.05$	0.2 ± 0.1	0.4	0.6	0.5				
0603	1608	1.55 <sup>+ 0.10</sup> - 0.05	0.85 ± 0.1	$0.45 \pm 0.05$	0.3 ± 0.2	$0.3 \pm 0.2$	0.5	0.9	1.0	0.9	0.9	1.0	
0805	2012	2.0 + 0.20 - 0.10	1.25 ± 0.15	$0.45 \pm 0.05$	0.3 + 0.20 - 0.10	$0.3 \pm 0.2$	0.7	1.3	1.2	0.9	1.3	1.3	
1206	3216	3.2 + 0.10	1.6 ± 0.15	$0.55 \pm 0.05$	0.45 ± 0.2	$0.4 \pm 0.2$	0.9	1.7	2.0	1.1	1.7	2.3	
1210	3225	$3.2 \pm 0.2$	$2.5 \pm 0.2$	$0.55 \pm 0.05$	$0.45 \pm 0.2$	$0.4 \pm 0.2$	0.9	2.5	2.0	1.1	2.5	2.2	
1218	3246	3.2 + 0.10	4.6 ± 0.15	$0.55 \pm 0.05$	0.45 ± 0.2	$0.4 \pm 0.2$	1.05	4.9	1.9	1.25	4.8	1.9	
2010	5025	5.0 ± 0.15	2.5 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	$0.6 \pm 0.2$	1.0	2.5	3.9	1.2	2.5	3.9	
2512	6332	$6.3 \pm 0.2$	3.15 ± 0.15	0.6 ± 0.1	0.6 ± 0.2	$0.6 \pm 0.2$	1.0	3.2	5.2	1.2	3.2	5.2	

Document Number: 20035 Revision: 04-Jun-12



### FUNCTIONAL PERFORMANCE





For technical questions, contact: thickfilmchip@vishay.com

Document Number: 20035 Revision: 04-Jun-12

THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <a href="http://www.vishay.com/doc?91000">www.vishay.com/doc?91000</a>



## Standard Thick Film Chip Resistors

150

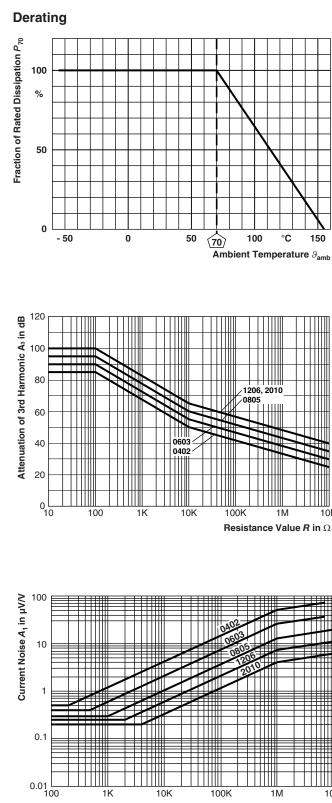
10M

10M

Resistance Value  $\pmb{R}$  in  $\Omega$ 

D/CRCW e3

Vishay



## Standard Thick Film Chip Resistors



TEST I	PROCED	URES AND REC	UIREMENTS					
IEC				REQUIREMENTS PERMISSIBLE CHANGE (AR)				
EN 60115-1	60068-2	TEST	PROCEDURE	SIZE 0402	to 2512			
CLAUSE	TEST METHOD			STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER			
			Stability for product types:					
			D/CRCW e3	1 Ω to 10 MΩ				
4.5	-	Resistance	-	± 1 %	± 5 %			
4.7	-	Voltage proof	<i>U</i> = 1.4 x <i>U</i> <sub>ins</sub> ; 60 s	No flashover o	r breakdown			
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{max};$ duration: Acc. to style	$\pm$ (0.25 % <i>R</i> + 0.05 Ω)	$\pm$ (0.5 % <i>R</i> + 0.05 Ω)			
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non activated flux; $(235 \pm 5) \degree C$ $(2 \pm 0.2) \$$	Good tinning (≥ 9 no visible 6				
4.17.2	58 (TU)	Solderability	Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; $(245 \pm 5) \ ^{\circ}C$ $(3 \pm 0.3) \ ^{\circ}S$	Good tinning (≥ 9 no visible e				
4.8.4.2	-	Temperature coefficient	(20/- 55/20) °C and (20/125/20) °C	± 100 ppm/K	± 200 ppm/K			
4.32	21 (Uu <sub>3</sub> )	Shear (adhesion)	RR 1608 and smaller: 9 N RR 2012 and larger: 45 N	No visible	damage			
4.33	21 (Uu <sub>1</sub> )	Substrate bending	Depth 2 mm; 3 times	No visible damage, no ope ± (0.25 % <i>R</i>	•			
4.19	14 (Na)	Rapid change of temperature	30 min. at - 55 °C; 30 min. at 125 °C 5 cycles 1000 cycles	± (0.25 % <i>R</i> + 0.05 Ω) ± (1 % <i>R</i> + 0.05 Ω)	± (0.5 % <i>R</i> + 0.05 Ω) ± (1 % <i>R</i> + 0.05 Ω)			
4.23	-	Climatic sequence:	-					
4.23.2	2 (Ba)	Dry heat	125 °C; 16 h					
4.23.3	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 1 cycle					
4.23.4	1 (Aa)	Cold	- 55 °C; 2 h	$\pm$ (1 % R + 0.05 Ω)	± (2 % $R$ + 0.1 Ω)			
4.23.5	13 (M)	Low air pressure	1 kPa; (25 ± 10) °C; 1 h					
4.23.6	30 (Db)	Damp heat, cyclic	55 °C; ≥ 90 % RH; 24 h; 5 cycles					
4.23.7	-	DC load	$U = \sqrt{P_{70} \times R}$					
4.05.4		Endurance	$U = \sqrt{P_{70} \times R} \le U_{\text{max.}};$ 1.5 h on; 0.5 h off;					
4.25.1	-	at 70 °C	70 °C; 1000 h	± (1 % <i>R</i> + 0.05 Ω)	± (2 % $R$ + 0.1 Ω)			
			70 °C; 8000 h	± (2 % <i>R</i> + 0.1 Ω)	$\pm$ (4 % R + 0.1 Ω)			



D/CRCW e3

Vishay

TEST PROCEDURES AND REQUIREMENTS								
	IEC			REQUIREMENTS PERMISSIBLE CHANGE (∆ <i>R</i> )				
EN 60115-1	60068-2	TEST	PROCEDURE	SIZE 0402 to 2512				
CLAUSE	TEST METHOD		THEOLDONE	STABILITY CLASS 1 OR BETTER	STABILITY CLASS 2 OR BETTER			
			Stability for product types:					
			D/CRCW e3	1 Ω to 1	0 ΜΩ			
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 ± 5) °C; (10 ± 1) s	$\pm$ (0.25 % R + 0.05 Ω)	$\pm$ (0.5 % R + 0.05 Ω)			
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning	after 30 s			
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (1 % <i>R</i> + 0.05 Ω)				
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	$\pm$ (1 % <i>R</i> + 0.05 Ω)	± (2 % <i>R</i> + 0.1 Ω)			
4.40	-	Electrostatic discharge (human body model)	IEC 61340-3-1; 3 pos. + 3 neg. discharges; ESD voltage acc. to size	± (1 % <i>R</i> +	· 0.05 Ω)			
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible	damage			
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking no visible				
4.22	6 (Fc)	Vibration, endurance by sweeping	$\label{eq:f} \begin{array}{l} f=10 \mbox{ Hz to } 2000 \mbox{ Hz;} \\ x, y, z \leq 1.5 \mbox{ mm;} \\ A \leq 200 \mbox{ m/s}^2; \\ 10 \mbox{ sweeps per axis} \end{array}$	± (0.25 % <i>R</i> + 0.05 Ω)	± (0.5 % <i>R</i> + 0.05 Ω)			
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{max.};$ 0.1 s on; 2.5 s off; 1000 cycles	± (1 % <i>R</i> + 0.05 Ω)				
4.27	-	Single pulse high voltage overload, 10 μs/700 μs	$\hat{U} = 10 \text{ x } \sqrt{P_{70} \text{ x } R}$ $\leq 2 \text{ x } U_{\text{max.}};$ $10 \text{ pulses}$	± (1 % <i>R</i> + 0.05 Ω)				

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x, environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3.



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for vishay manufacturer:

Other Similar products are found below :

M39006/22-0577H Y00892K49000BR13L M8340109M6801GGD03 ITU1341SM3 VS-MBRB1545CTPBF 1KAB100E IH10EB600K12 CP0005150R0JE1490 562R5GAD47RR S472M69Z5UR84K0R MKP1848C65090JY5L CRCW1210360RFKEA VSMF4720-GS08 TSOP34438SS1V CRCW04024021FRT7 001789X LT0050FR0500JTE3 CRCW0805348RFKEA LVR10R0200FE03 CRCW12063K30FKEAHP 009923A CRCW2010331JR02 CRCW25128K06FKEG CS6600552K000B8768 M39003/01-2289 M39003/01-2784 M39006/25-0133 M39006/25-0228 M64W101KB40 M64Z501KB40 CW001R5000JS73 CW0055R000JE12 CW0056K800JB12 CW0106K000JE73 672D826H075EK5C CWR06JC105KC CWR06NC475JC MAL219699001E3 MCRL007035R00JHB00 GBU4K-E3/51 GBU8M-E3/51 PTF56100K00QYEK PTN0805H1502BBTR1K RCWL1210R130JNEA RH005220R0FE02 RH005330R0FC02 RH010R0500FC02 132B20103 RH1007R000FJ01 RH2503R500FE01